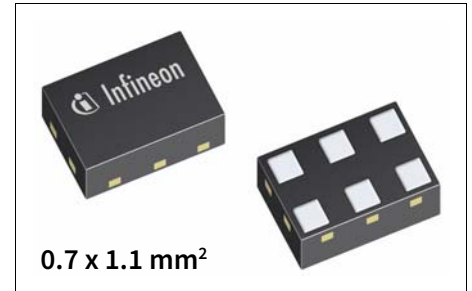


# BGA5M1BN6

## 18dB High Gain Low Noise Amplifier for LTE Midband

### Features

- Operating frequencies: 1805 - 2200 MHz
- Insertion power gain: 19.3 dB
- Insertion Loss in bypass mode: 4.7 dB
- Low noise figure: 0.65 dB
- Low current consumption: 9.5 mA
- Multi-state control: Bypass- and high gain-Mode
- Ultra small TSNP-6-10 leadless package
- RF output internally matched to 50 Ohm
- Low external component count



### Application

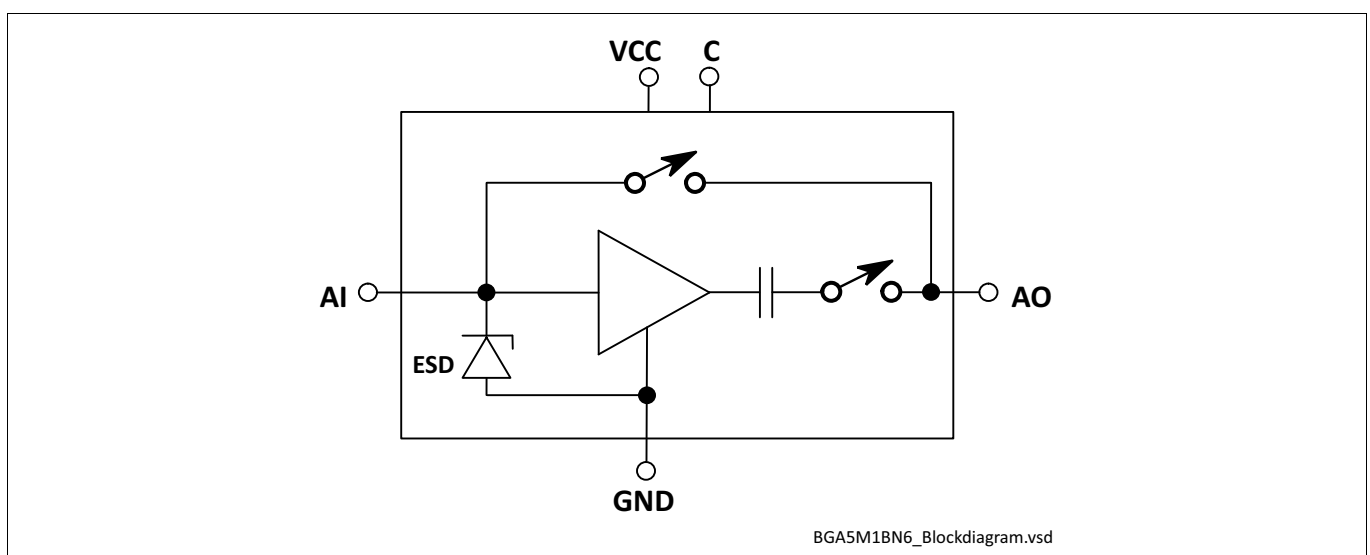
The LTE data rate can be significantly improved by using the Low Noise Amplifier. The integrated bypass function increases the overall system dynamic range and leads to more flexibility in the RF front-end.

In high gain mode the LNA offers best Noise Figure to ensure high data rates even on the LTE cell edge. Closer to the basestation the bypass mode can be activated reducing current consumption.

### Product Validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Block diagram



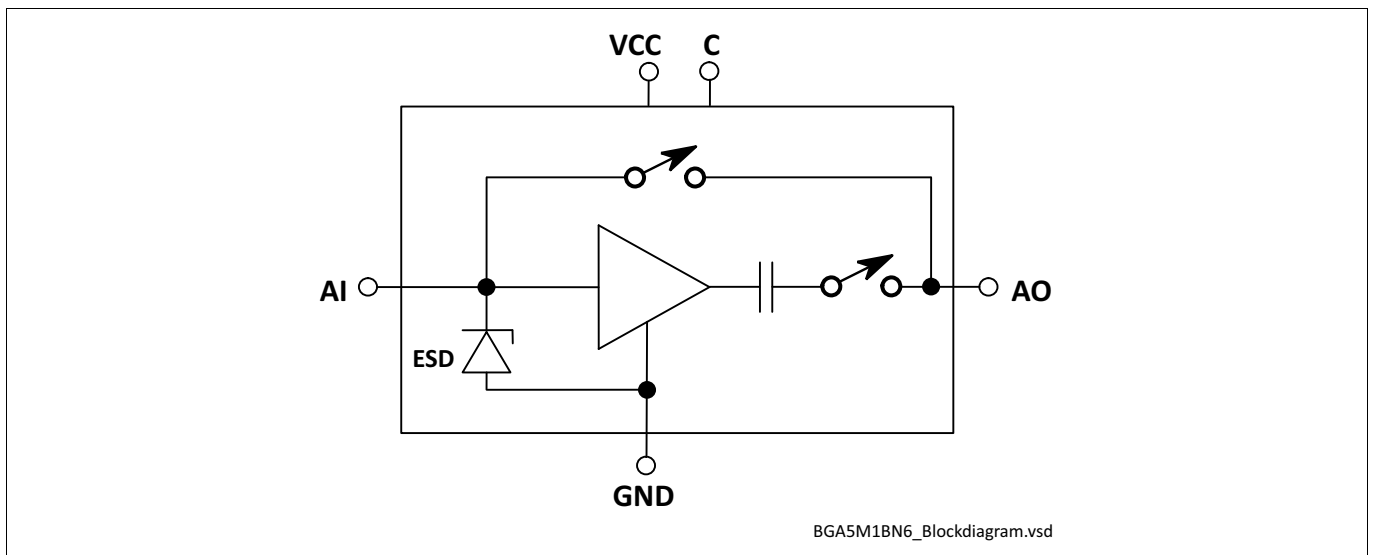
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**Features**

**1 Features**

- Insertion power gain: 19.3 dB
- Insertion Loss in bypass mode: 4.7 dB
- Low noise figure: 0.65 dB
- Low current consumption: 9.5 mA
- Operating frequencies: 1805 - 2200 MHz
- Multi-state control: Bypass- and High gain-Mode
- Supply voltage: 1.5 V to 3.6 V
- Ultra small TSNP-6-10 leadless package (footprint: 0.7 x 1.1 mm<sup>2</sup>)
- B9HF Silicon Germanium technology
- RF output internally matched to 50 Ohm
- Low external component count
- Pb-free (RoHS compliant) package



**Figure 1 Block Diagram**

Product Name	Marking	Package
BGA5M1BN6	5	TSNP-6-10

# BGA5M1BN6

## 18dB High Gain Low Noise Amplifier for LTE Midband



### Features

### Description

The BGA5M1BN6 is a front-end low noise amplifier for LTE which covers a wide frequency range from 1805 MHz to 2200 MHz. The LNA provides 19.3 dB gain and 0.65 dB noise figure at a current consumption of 9.5 mA in the application configuration described in [Chapter 4](#). In bypass mode the LNA provides an insertion loss of 4.7 dB. The BGA5M1BN6 is based upon Infineon Technologies' B9HF Silicon Germanium technology. It operates from 1.5 V to 3.6 V supply voltage. The device features a single-line two-state control (Bypass- and High gain-Mode). OFF-state can be enabled by powering down VCC.

### Pin Definition and Function

**Table 1 Pin Definition and Function**

Pin No.	Name	Function
1	GND	Ground
2	VCC	DC supply
3	AO	LNA output
4	GND	Ground
5	AI	LNA input
6	C	Control

**Maximum Ratings**

**2 Maximum Ratings**

**Table 2 Maximum Ratings**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Voltage at pin VCC	$V_{CC}$	-0.3	–	3.6	V	1)
Voltage at pin AI	$V_{AI}$	-0.3	–	0.9	V	–
Voltage at pin AO	$V_{AO}$	-0.3	–	$V_{CC} + 0.3$	V	–
Voltage at pin C	$V_C$	-0.3	–	$V_{CC} + 0.3$	V	–
Voltage at pin GND	$V_{GND}$	-0.3	–	0.3	V	–
Current into pin VCC	$I_{CC}$	–	–	16	mA	–
RF input power	$P_{IN}$	–	–	+25	dBm	–
Total power dissipation, $T_S < 148\text{ °C}^2)$	$P_{tot}$	–	–	60	mW	–
Junction temperature	$T_J$	–	–	150	°C	–
Ambient temperature range	$T_A$	-40	–	85	°C	–
Storage temperature range	$T_{STG}$	-55	–	150	°C	–

1) All voltages refer to GND-Node unless otherwise noted

2)  $T_S$  is measured on the ground lead at the soldering point

**Attention:** *Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.*

**Electrical Characteristics**

**3 Electrical Characteristics**

**Table 3 Electrical Characteristics  $V_{CC} = 1.8V^{1)}$**

$T_A = 25\text{ }^\circ\text{C}$ ,  $V_{CC} = 1.8\text{ V}$ ,  $V_{C,BP} = 1.8\text{ V}$ ,  $V_{C,OFF} = 0\text{ V}$ ,  $f = 1805 - 2200\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_{CC}$	1.5	1.8	3.6	V	–
Control voltages	$V_C$	1.0	–	$V_{CC}$	V	High gain mode
		0	–	0.4	V	Bypass mode
Supply current	$I_{CC}$	–	9.5	11.0	mA	High gain mode
		–	85	120	$\mu\text{A}$	Bypass mode
Insertion power gain $f = 2000\text{ MHz}$	$ S_{21} ^2$	17.8	19.3	20.8	dB	High gain mode
		-5.9	-4.7	-3.5	dB	Bypass mode
Noise figure <sup>2)</sup> $f = 2000\text{ MHz}$ , $Z_S = 50\ \Omega$	$NF$	–	0.65	1.15	dB	High gain mode
		–	4.7	5.9	dB	Bypass mode
Input return loss <sup>3)</sup> $f = 2000\text{ MHz}$	$RL_{IN}$	9	12	–	dB	High gain mode
		5	8	–	dB	Bypass mode
Output return loss <sup>3)</sup> $f = 2000\text{ MHz}$	$RL_{OUT}$	10	18	–	dB	High gain mode
		3	5	–	dB	Bypass mode
Reverse isolation <sup>3)</sup> $f = 2000\text{ MHz}$	$1/ S_{12} ^2$	25	37	–	dB	High gain mode
		3.5	4.7	–	dB	Bypass mode
Power on time <sup>4)6)</sup>	$t_S$	–	3	7	$\mu\text{s}$	OFF to High gain mode
Inband input 1dB-compression point, $f = 2000\text{ MHz}^{3)}$	$IP_{1dB}$	-21	-17	–	dBm	High gain mode
		-6	-2	–	dBm	Bypass mode
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)5)</sup> $f_1 = 2000\text{ MHz}$ , $f_2 = f_1 \pm 1\text{ MHz}$	$IIP_3$	-12	-7	–	dBm	High gain mode
		1	6	–	dBm	Bypass mode
Stability <sup>6)</sup>	$k$	> 1	–	–		$f = 20\text{ MHz} \dots 10\text{ GHz}$

1) Based on the application described in [Chapter 4](#)

2) PCB losses are subtracted

3) Verification based on AQL; not 100% tested in production

4) Gain changed to >90% of gain difference (in dB)

5) Input power HG = -30 dBm for each tone; input power BP = -10 dBm for each tone

6) Guaranteed by device design; not tested in production

**Electrical Characteristics**

**Table 4 Electrical Characteristics  $V_{CC} = 2.8V$ <sup>1)</sup>**

$T_A = 25\text{ }^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$ ,  $V_{C,BP} = 2.8\text{ V}$ ,  $V_{C,OFF} = 0\text{ V}$ ,  $f = 1805 - 2200\text{ MHz}$

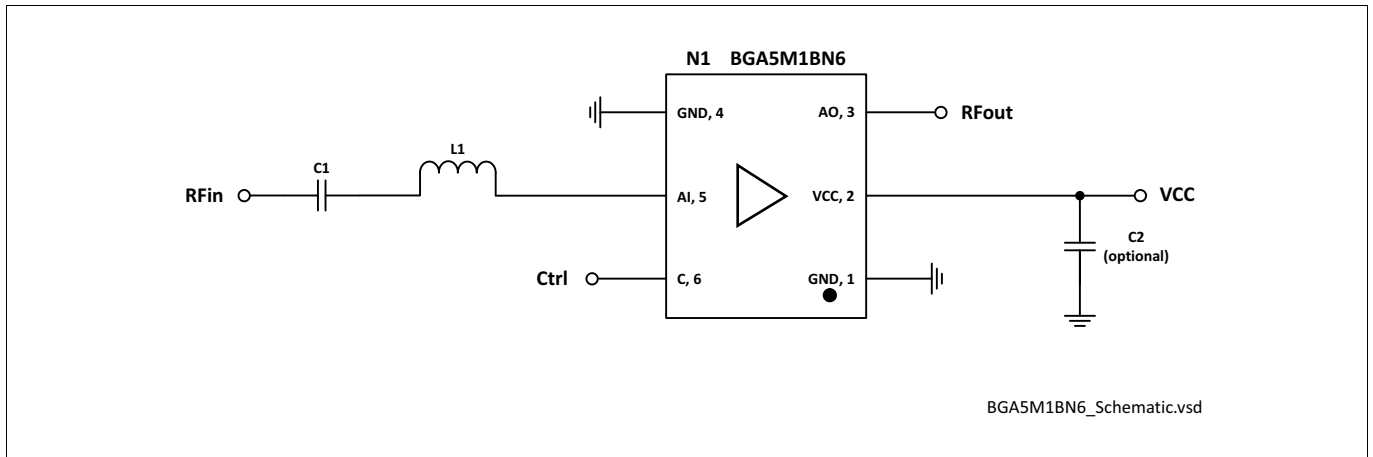
Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_{CC}$	1.5	2.8	3.6	V	–
Control voltages	$V_C$	1.0	–	$V_{CC}$	V	High gain mode
		0	–	0.4	V	Bypass mode
Supply current	$I_{CC}$	–	10.3	11.8	mA	High gain mode
		–	87	120	$\mu\text{A}$	Bypass mode
Insertion power gain $f = 2000\text{ MHz}$	$ S_{21} ^2$	17.9	19.4	20.9	dB	High gain mode
		-5.9	-4.7	-3.5	dB	Bypass mode
Noise figure <sup>2)</sup> $f = 2000\text{ MHz}$ , $Z_S = 50\ \Omega$	$NF$	–	0.65	1.15	dB	High gain mode
		–	4.7	5.9	dB	Bypass mode
Input return loss <sup>3)</sup> $f = 2000\text{ MHz}$	$RL_{IN}$	9	12	–	dB	High gain mode
		5	8	–	dB	Bypass mode
Output return loss <sup>3)</sup> $f = 2000\text{ MHz}$	$RL_{OUT}$	10	17	–	dB	High gain mode
		3	5	–	dB	Bypass mode
Reverse isolation <sup>3)</sup> $f = 2000\text{ MHz}$	$1/ S_{12} ^2$	25	37	–	dB	High gain mode
		3.5	4.7	–	dB	Bypass mode
Power on time <sup>4)6)</sup>	$t_S$	–	3	7	$\mu\text{s}$	OFF to High gain mode
Inband input 1dB-compression point, $f = 2000\text{ MHz}$ <sup>3)</sup>	$IP_{1dB}$	-20	-16	–	dBm	High gain mode
		-6	-2	–	dBm	Bypass mode
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)5)</sup> $f_1 = 2000\text{ MHz}$ , $f_2 = f_1 \pm 1\text{ MHz}$	$IIP_3$	-12	-7	–	dBm	High gain mode
		1	6	–	dBm	Bypass mode
Stability <sup>6)</sup>	$k$	> 1	–	–		$f = 20\text{ MHz} \dots 10\text{ GHz}$

- 1) Based on the application described in [Chapter 4](#)
- 2) PCB losses are subtracted
- 3) Verification based on AQL; not 100% tested in production
- 4) Gain changed to >90% of gain difference (in dB)
- 5) Input power HG = -30 dBm for each tone; input power BP = -10 dBm for each tone
- 6) Guaranteed by device design; not tested in production

**Application Information**

**4 Application Information**

**Application Board Configuration**



**Figure 2 Application Schematic BGA5M1BN6**

**Table 5 Bill of Materials**

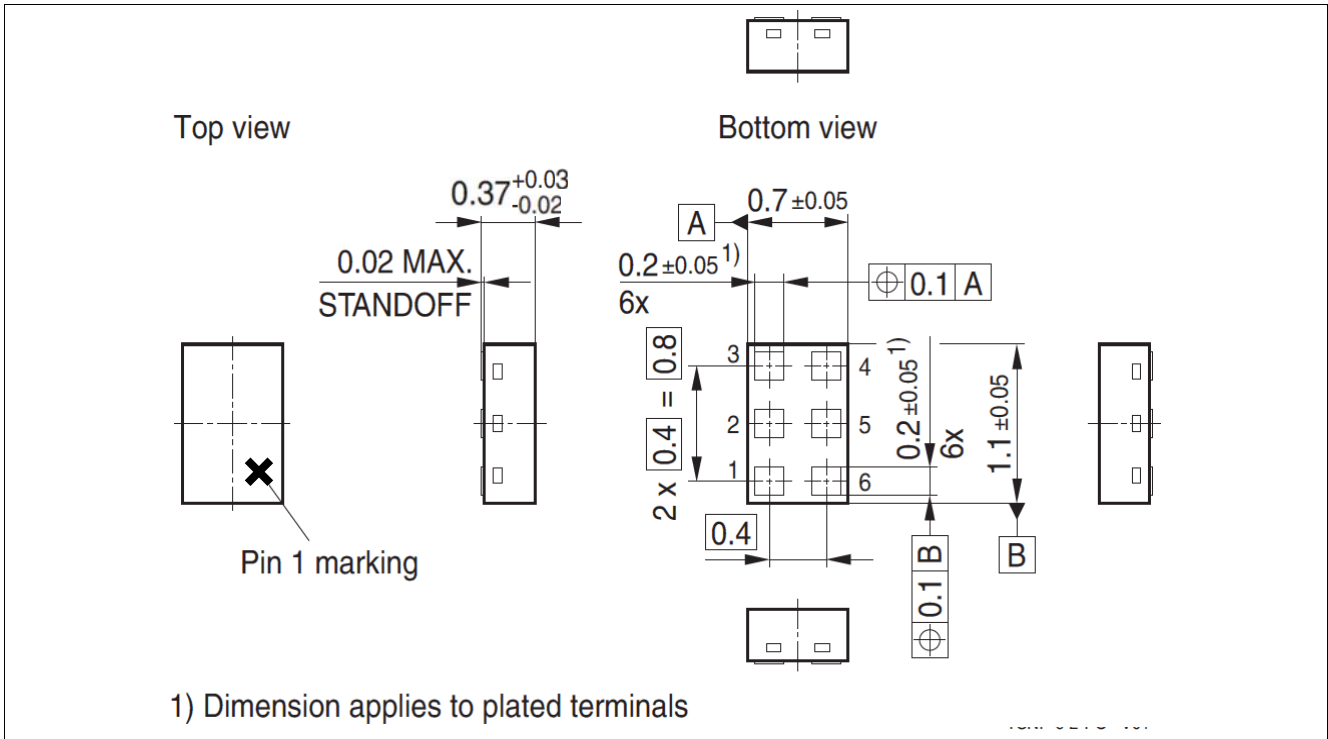
Name	Value	Package	Manufacturer	Function
C1	1nF	0402	Various	Input matching
C2 (optional)	≥ 1nF	0402	Various	RF bypass <sup>1)</sup>
L1	5.2nH	0402	Murata LQW15 type	Input matching
N1	BGA5M1BN6	TSNP-6-10	Infineon	SiGe LNA

1) RF bypass recommended to mitigate power supply noise

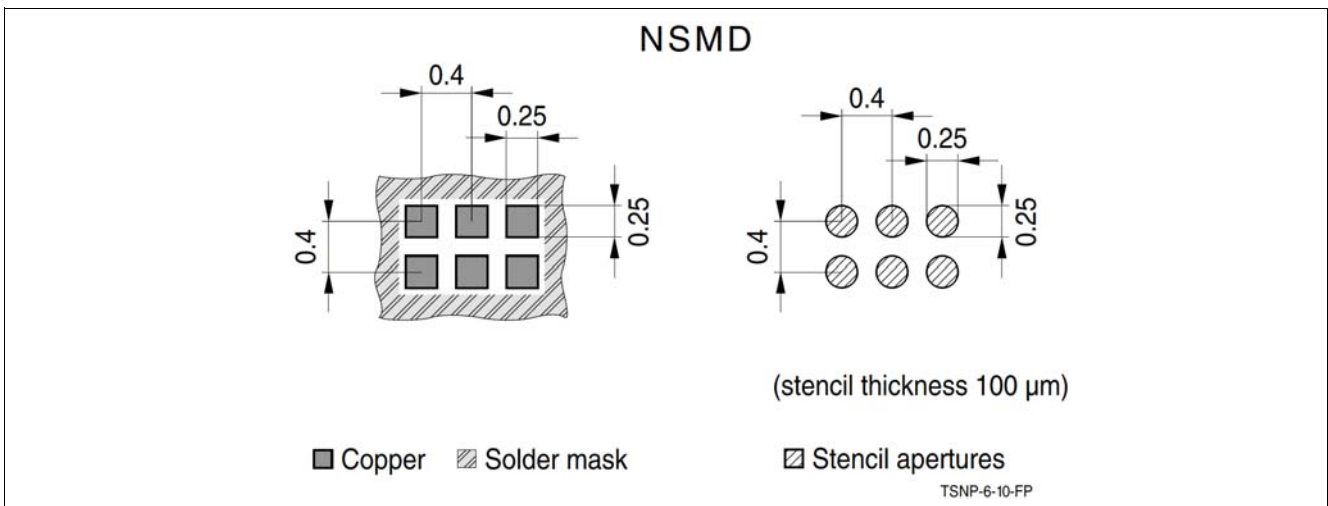
A list of all application notes is available at <http://www.infineon.com/ltelna>



## 5 Package Information

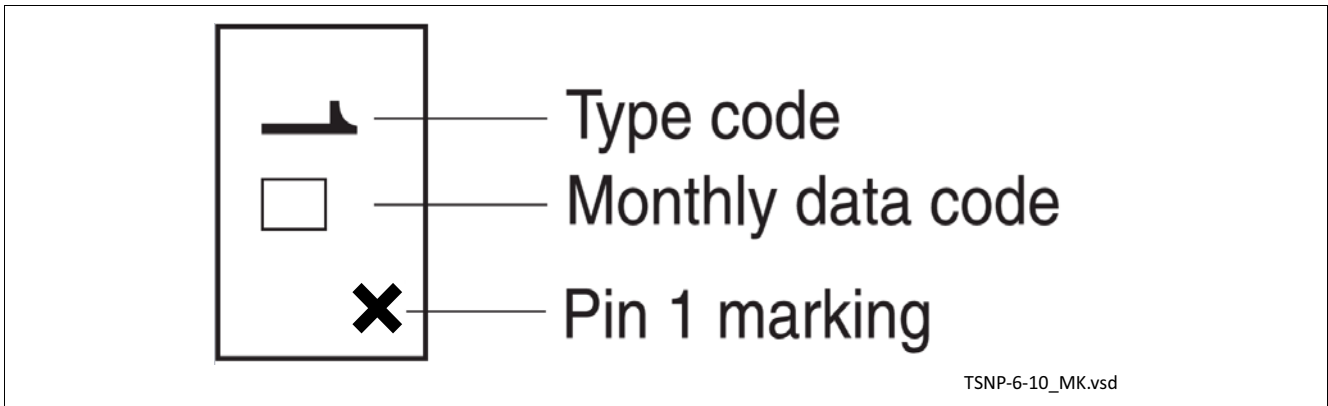


**Figure 3** TSNP-6-10 Package Outline (top, side and bottom views)



**Figure 4** Footprint Recommendation TSNP-6-10

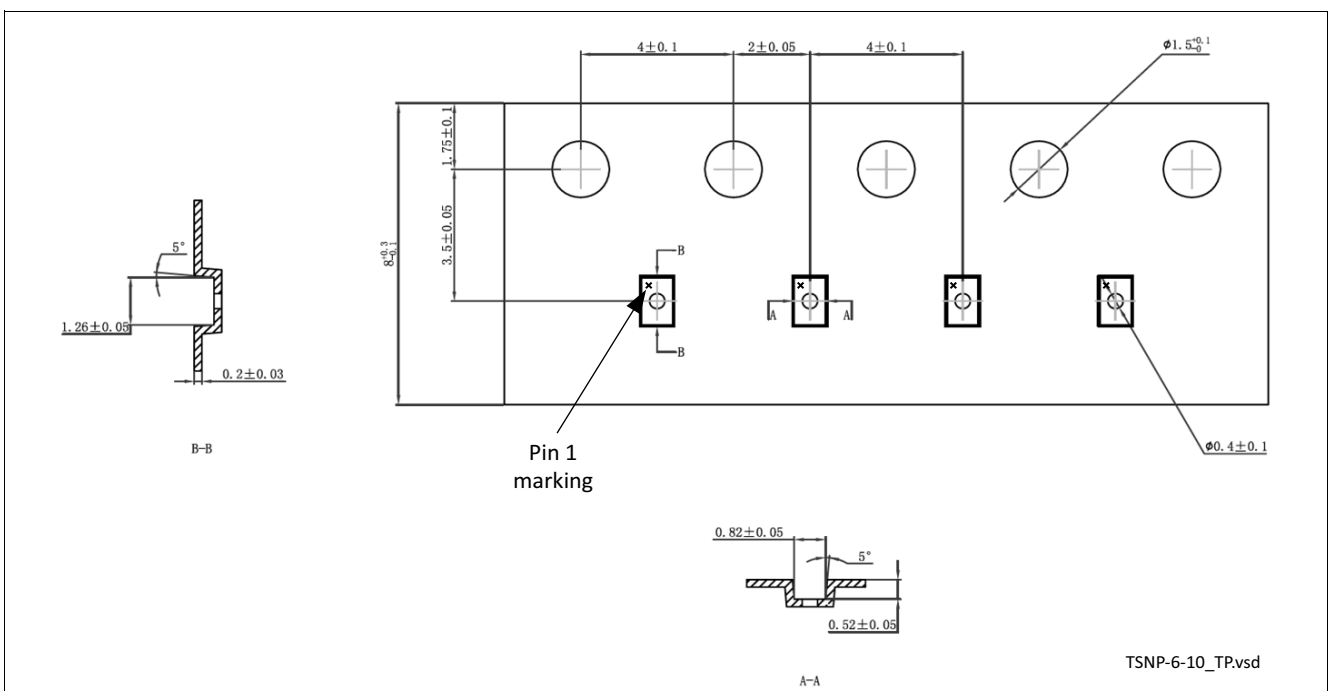
**Package Information**



**Figure 5 Marking Layout TSNP-6-10 (top view)**

Month	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

**Figure 6 Date Code Marking TSNP-6-10**



**Figure 7 Tape & Reel Dimensions TSNP-6-10 (reel diameter 180 mm, pieces/reel 12000)**

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**Revision History**

<b>Page or Item</b>	<b>Subjects (major changes since previous revision)</b>
<b>Revision 2.2, 2018-03-15</b>	
all	Update Package Information

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